

# SML-E1 series

#### Features

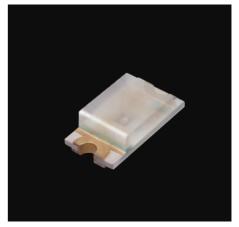
- EXCELED<sub>TM</sub> series
- Compact, Thin size (1.6×0.8mm, t=0.36mm)
- · LED die consists of 4 elements
- · Original device technology enables high brightness and high reliability
- LED die position is middle of package.

#### ●Size

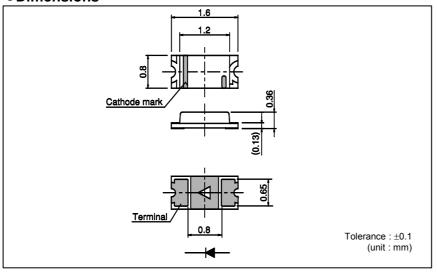
1608 (0603)  $1.6 \times 0.8$ mm (t=0.36mm)



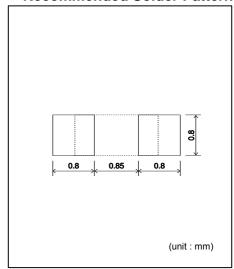
#### Outline



### Dimensions



### Recommended Solder Pattern



### Specifications

				Abs	olute Max	kimum Ra	atings (Ta=25°C	C)			Electri	cal and	Optica	l Char	acterist	cs (Ta	=25°C)		
Part No.	Chip	Emitting			Peak Forward		Operating Temp.	Storage Temp.	Forward	Voltag V <sub>F</sub>	Reverse				aveleng	th λD			nsity I <sub>V</sub>
	Structure	Color		Current		Voltage			Typ.	I <sub>F</sub>	Max.	V <sub>R</sub>			Max.*3	l <sub>F</sub>		Typ.	l <sub>F</sub>
0141 5401/014					I <sub>FP</sub> (mA)		Topr(°C)	Tstg(°C)	(V)	(mA)	(μ <b>A</b> )	(V)			(nm)	(mA)			(mA)
SML-E12V8W			54	20	100*2	5	-40 to +85	-40 to +100	2.2				625	630	635		16	40	
SML-E12UW		Red	62	25	60*1	4	-30 to +85	-40 to +85	2.1				619	624	629		36	100	
SML-E12U8W			54	20	100*2	5	-40 to +85	-40 to +100	2.2				615	620	625		25	63	
SML-E12DW	AlGalnP	Orange	62	25	60*1	4	-30 to +85	-40 to +85	1.9	20		4	603.5	606.5	609.5	20	56	200	20
SML-E12D8W	on GaAs	Orange								20	10	4	602	605	608	20	40	100	20
SML-E12Y8W		Yellow							2.2		10		587	590	593		25	63	
SML-E12M8W		Yellowish Green	54	20	100*²		-40 to +85		2.2				569	572	575		10	25	
SML-E12P8W		Green		20	100	5		-40 to +100					557	560	563		2.5	6.3	
SMLE13EC8T		Bluish Green	68						3.0				520	527	535		56	120	
SMLE13BC8T	InGaN	Blue	66				-40 to +85		2.9	5		5	465	470	475	5	14	40	5
SMLE13WBC8W		White	33	10	50 <sup>*2</sup>		-40 to +85		2.9		100		(0.	30, 0.	30)		56	120	

\*1 : Duty 1/5, 200Hz \*2 : Duty 1/10, 1kHz \*3 : Reference

<sup>\*</sup>EXCELED<sup>TM</sup> is ROHM's pending tradmark.

### • Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

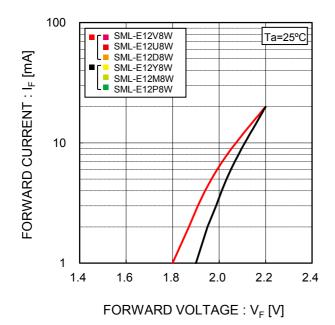


Fig.2 Luminous Intensity -Atmosphere Temperature 1.6 RELATIVE LUMINOUS INTENSITY [a.u.] I<sub>F</sub>=20mA 1.4 1.2 1 8.0 SML-E12V8W SML-E12U8W SML-E12D8W 0.6 SML-E12Y8W SML-E12M8W SML-E12P8W 0.4 -20 0 20 40 60 100 -40 80

ATMOSPHERE TEMPERATURE : Ta [°C]

Fig.3 Luminous Intensity - Forward Current

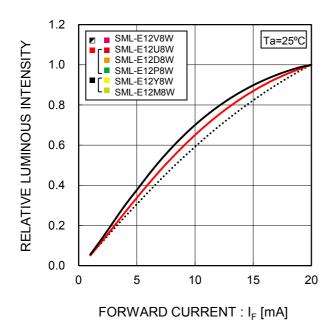
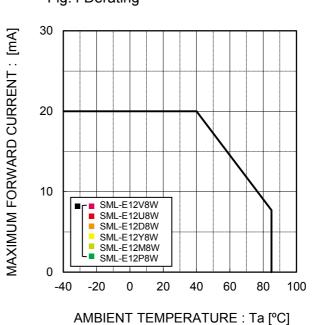


Fig.4 Derating



### • Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

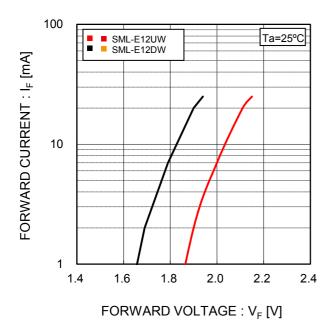


Fig.2 Luminous Intensity -Atmosphere Temperature 1.6 RELATIVE LUMINOUS INTENSITY [a.u.] I<sub>F</sub>=20mA 1.4 1.2 1 8.0 0.6 0.4 SML-E12UW SML-E12DW 0.2 -20 0 20 40 60 80 100 -40

ATMOSPHERE TEMPERATURE : Ta [°C]

Fig.3 Luminous Intensity - Forward Current

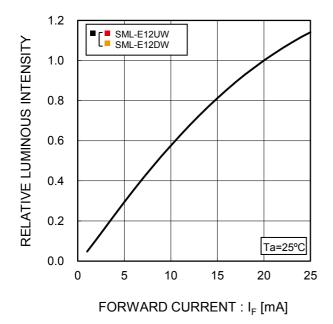
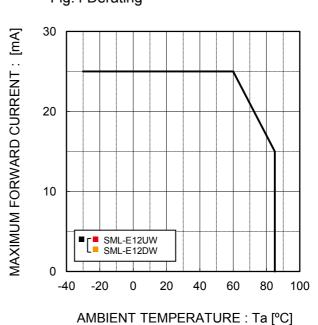


Fig.4 Derating



### • Electrical Characteristics Curves

Fig.1 Forward Current - Forward Voltages

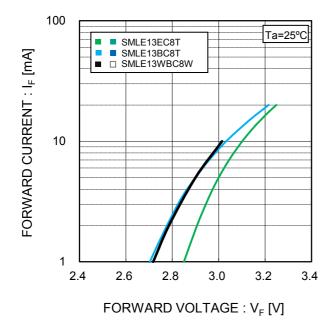


Fig.2 Luminous Intensity -Atmosphere Temperature 1.4 RELATIVE LUMINOUS INTENSITY [a.u.] I₌=5mA 1.2 1 8.0 SMLE13EC8T SMLE13BC8T SMLE13WBC8W 0.6 -40 -20 0 20 40 60 80 100

ATMOSPHERE TEMPERATURE : Ta [°C]

Fig.3 Luminous Intensity - Forward Current

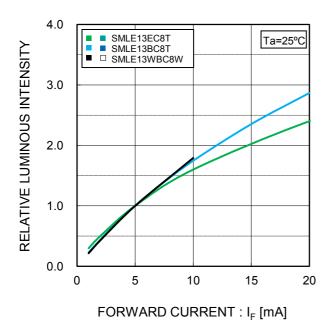
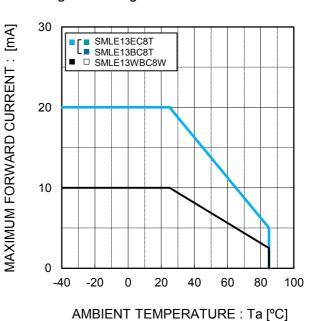
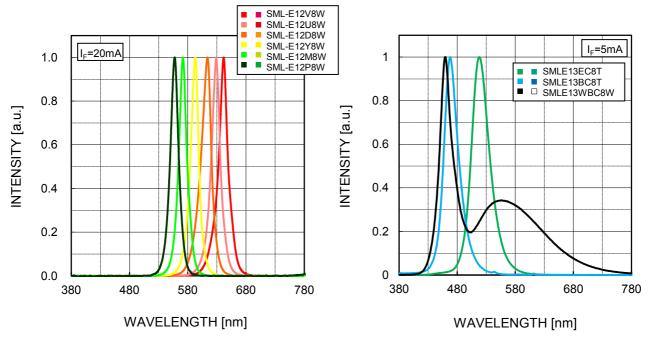


Fig.4 Derating



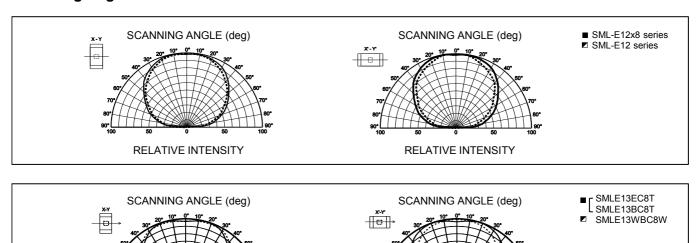
### Spectrum Data



<sup>\*</sup> Please take this data as a reference data for the samples are measured randomly.

RELATIVE INTENSITY

### Viewing Angle



RELATIVE INTENSITY

<sup>\*</sup> The data is relativized for each color. It is NOT to show the spectrum peaks are equal.

## ● Rank Reference of Brightness

Red(V,U) (Ta=25°C, I<sub>F</sub>=20mA)

,														( .	, .,	,
Rank	G	Н	J	K	L	M	N	Р	Q	R	S	Т	U	V	W	X
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-E12V8W																
SML-E12U8W																
SML-E12UW*																

Orange(D)  $(Ta=25^{\circ}C, I_F=20mA)$ 

														( -	, .,	
Rank	G	Н	J	K	L	M	N	Р	Q	R	S	T	U	V	W	Х
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-E12DW*																
SML-E12D8W																

Yellow(Y) (Ta=25°C, I<sub>F</sub>=20mA)

• • •														,		,
Rank	G	Н	J	K	L	М	N	Р	Q	R	S	T	U	V	W	Х
Iv (mcd)	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-E12Y8W																

Green(M,P)  $(Ta=25^{\circ}C, I_{F}=20mA)$ 

Rank	F	G	Н	J	K	L	M	N	Р	Q	R	S	T	U	V	W	Χ
Iv (mcd)	0.63 to 1.0	1.0 to 1.6	1.6 to 2.5	2.5 to 4.0	4.0 to 6.3	6.3 to 10	10 to 16	16 to 25	25 to 40	40 to 63	63 to 100	100 to 160	160 to 250	250 to 400	400 to 630	630 to 1000	1000 to 1600
SML-E12M8W																	
SML-E12P8W																	

Bluish Green(E)

		(—)												(1)	a-25 C, 15	:-3111/
ĺ	Rank	K	L	М	N	Р	Q	R	S	Т	U	V	W	Х	Υ	Z
ĺ	Iv (mcd)	3.6 to 5.6	5.6 to 9.0	9 to 14	14 to 22	22 to 36	36 to 56	56 to 90	90 to 140	140 to 220	220 to 360	360 to 560	560 to 900	900 to 1400	1400 to 2200	2200 to 3600
Ī	SMLE13EC8T															

Blue(B) (Ta=25°C, I<sub>F</sub>=5mA)

` '													١.	۰ ۵ ۰, ۱٫	
Rank	K	L	M	N	Р	Q	R	S	Т	U	V	W	X	Υ	Z
Iv (mcd)	3.6 to 5.6	5.6 to 9.0	9 to 14	14 to 22	22 to 36	36 to 56	56 to 90	90 to 140	140 to 220	220 to 360	360 to 560	560 to 900	900 to 1400	1400 to 2200	2200 to 3600
SMLE13BC8T															

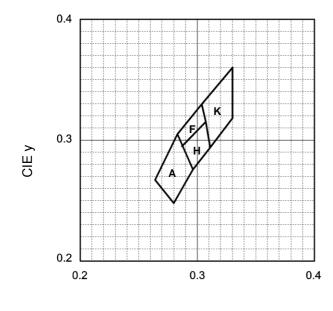
White(WB)

vvriite(vvb)			(10 20 0, 1) 0.107)														
Rank	K	L	M	N	Р	Q	R	S	Т	U	V	W	Х	Υ	Z		
lv (mcd)	3.6 to 5.6	5.6 to 9.0	9 to 14	14 to 22	22 to 36	36 to 56	56 to 90	90 to 140	140 to 220	220 to 360	360 to 560	560 to 900	900 to 1400	1400 to 2200	2200 to 3600		
SMLE13WBC8W																	

\* : Measurement tolerance ±10%

(Ta=25°C | =5mA)

# Chromaticity Diagram



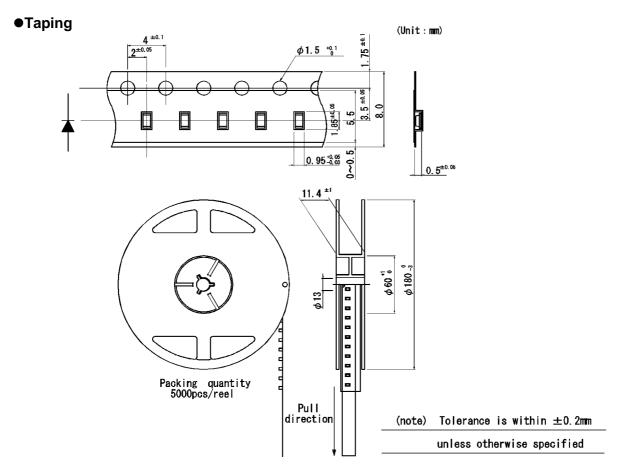
# [Chromaticity Coordinates]

SMLE <sup>2</sup>	13WBC	W8			(Ta=25	5°C, l <sub>F</sub> =	=5mA)
,	4		F	ŀ	+	ŀ	<
х	у	Х	у	х	у	х	у
0.280	0.248	0.283	0.305	0.287	0.295	0.304	0.330
0.296	0.276	0.304	0.330	0.307	0.315	0.330	0.360
0.283	0.305	0.307	0.315	0.311	0.294	0.330	0.318
0.264	0.267	0.287	0.295	0.296	0.276	0.311	0.294

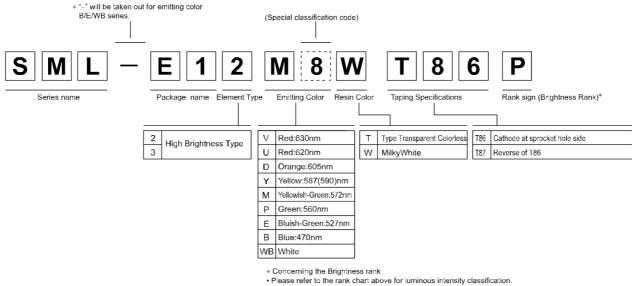
Measurement tolerance: ±0.02

ROHM

**Data Sheet SML-E1 series** 



#### ●Part No. Construction



- Part name is individual for each rank.
  When shipped as sample, the part name will be a representative part name. General products are free of ranks. Please contact sales if rank appointment is needed.

### Packing Specification

ROHM LED products are being shipped with desiccant (silica gel) concluded in moisture-proof bags.

Pasting the moisture sensitive label on the outer surface of the moisture-proof bags or enclosing the humidity indication card inside the bag is available upon request.

Please contact the nearest sales office or distributer if necessary.

### Attention Points In Handling

This product was developed as a surface mount LED especially suitable for reflow soldering.

Please take care of following points when using this device

#### 1. DESIGNING OF PCB

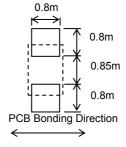
As for a recommendable solder pattern, Please refer to Fig-1.

The size and direction of the pad pattern depend on the condition of the PCB.

Thorough design review is recommended before the final designing.

This product of structured with rear/bottom electrode to be soldered.

The formation of solder fillet is not guaranteed due to its electrode shape



#### 2. SOLDERING (Sn-Cu, Sn-Ag-Cu, Sn-Ag-Bi-Cu)

LED products do not contain reinforcement materials such as glass fillers.

Therefore, thermal stress by soldering greatly

influences its reliability.

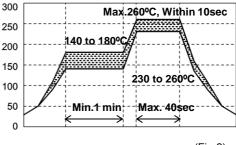
The temperature conditions for reflow soldering

should therefore be set up according to the characteristic of this product. (See Fig-2)

Number of reflow process shall be max 2 times

and these processes shall be performed in a row.

Cooling process to normal temperature shall be required



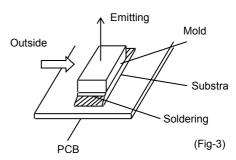
(Fig-2)

### 3. HANDLING AFTER MOUNTING (Fig.-3)

As shown in the drawing on the right, in case outside force of about 700g is given to the device, stress is concentrated to the jointed part between mold resin and substrate.

Therefore there is a possibility to breath the device or PCB.

Careful handing is needed as ROHM cannot guarantee the falling of the device by outside force after mounting.



#### 4. WASHING

Please note the following points when washing is required after soldering.

#### 4-1) WASHING SOLVENT

Isopropyl alcohol or other alcohol solvent is recommendable.

#### 4-2) TEMPERATURE

Below 30°C, immersion time; within 3 minutes.

#### 4-3) ULTRA SONIC WASHING

Below 15W/1 litter of solvent tub or less.

### 4-4) COOLING

Below 100°C within 3 minutes.

#### 5.EROSION GAS

Utilization in erosion gas atmosphere may degenerate the plating surface which might cause deterioration of solder strength, optical characteristics, or functions.

Please take precautions against occurrence of gas from the surrounding parts on the occasion of custody, and also after mounted on circuit board.

#### 6. STORAGE

At reflow soldering, the reliability of this product is often influenced by moisture absorption so we apply the packaging with moisture proof for better condition is use, please also note that 6-1) Not to be opened before using.

- 6-2) To be kept in our moisture proof packaging with some desiccant (SILICA GEL) after opening it.

  To be baked in case the SILICA GEL indicator its color from either blue to clear or green to pink.
- 6-3) Please use within 168 hours after the package was opened. (Condition at 30°C, max.70%Rh.) In case it is not used within 168 hours, please put it back into our packaging.

#### 6-4) BAKING

Please bake under reel condition at 60°C, 12 to 24 hours (max.20%Rh) after un-sealing. While baking is done, the reel and emboss tape may be easily deformed. Please be careful not to give any stress.

#### 7. LIFE TIME

This product will cause reduction of luminous intensity depending on the using conditions and environmental. Please inquire our sales contact if long life time is required on your application.

### Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications:
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communication, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.
- 7) The Products specified in this document are not designed to be radiation tolerant.
- 8) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
- Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 10) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 11) ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
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>>ROHM Semiconductor(罗姆)